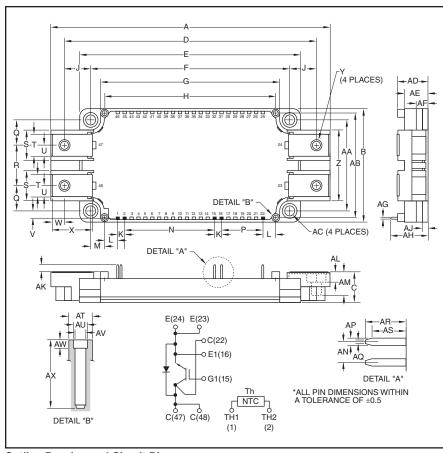


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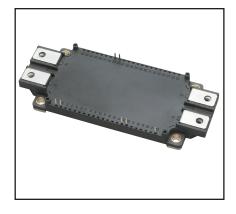
# Single IGBT **NX-Series Module** 600 Amperes/600 Volts



#### **Outline Drawing and Circuit Diagram**

Dimensions	Inches	Millimeters
Α	5.98	152.0
В	2.44	62.0
С	0.67	17.0
D	5.39	137.0
Е	4.79	121.7
F	4.33±0.02	110.0±0.5
G	3.89	99.0
Н	3.72	94.5
J	0.53	13.5
K	0.15	3.8
L	0.28	7.25
M	0.30	7.75
N	1.95	49.54
Р	0.9	22.86
Q	0.55	14.0
R	0.87	22.0
S	0.67	17.0
Т	0.48	12.0
U	0.24	6.0
V	0.16	4.2
W	0.37	6.5
X	0.83	21.14
Υ	M6	M6

Dimensions	Inches	Millimeters
Z	1.53	39.0
AA	1.97±0.02	50.0±0.5
AB	2.26	57.5
AC	0.22 Dia.	5.5 Dia.
AD	0.67+0.04/-0.02	17.0+1.0/-0.5
AE	0.51	13.0
AF	0.27	7.0
AG	0.03	8.0
AH	0.81	20.5
AJ	0.12	3.0
AK	0.14	3.5
AL	0.21	5.4
AM	0.49	12.5
AN	0.15	3.81
AP	0.05	1.15
AQ	0.025	0.65
AR	0.29	7.4
AS	0.24	6.2
AT	0.17 Dia.	4.3 Dia.
AU	0.10 Dia.	2.5 Dia.
AV	0.08 Dia.	2.1 Dia.
AW	0.06	1.5
AX	0.49	12.5



### **Description:**

Powerex IGBT Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

#### Features:

- ☐ AlSiC Baseplate
- □ Low Drive Power
- □ Low V<sub>CE(sat)</sub>□ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ Isolated Baseplate for Easy **Heat Sinking**

### **Applications:**

- ☐ AC Motor Control
- □ Motion/Servo Control
- ☐ Photovoltaic/Fuel Cell



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QIS0660004 Single IGBT NX-Series Module 600 Amperes/600 Volts

### Absolute Maximum Ratings, T<sub>i</sub> = 25°C unless otherwise specified

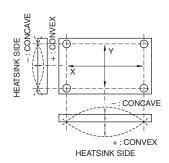
Characteristics	Symbol	QIS0660004	Units
Power Device Junction Temperature	Тј	-40 to 150	°C
Storage Temperature	T <sub>stg</sub>	-55 to 130	°C
Mounting Torque, M5 Mounting Screws	_	31	in-lb
Mounting Torque, M6 Main Terminal Screws	_	40	in-lb
Module Weight (Typical)	_	220	Grams
Baseplate Flatness, On Centerline X, Y (See Below)	_	±0 ~ +100	μm
Isolation Voltage, AC 1 minute, 60Hz Sinusoidal	V <sub>ISO</sub>	2500	Volts

#### **Inverter Sector**

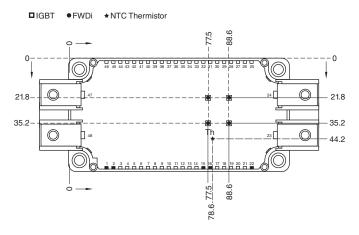
mitoriol Godiol			
Collector-Emitter Voltage (G-E Short)	V <sub>CES</sub>	600	Volts
Gate-Emitter Voltage (C-E Short)	V <sub>GES</sub>	±20	Volts
Collector Current (T <sub>C</sub> = 55°C)*1*4*9	I <sub>C</sub>	600	Amperes
Peak Collector Current (Pulse)*3	I <sub>CM</sub>	1200	Amperes
Emitter Current $(T_C = 25^{\circ}C)^{*1*4*9}$	IE <sup>*2</sup>	600	Amperes
Peak Emitter Current (Pulse)*3	I <sub>EM</sub> *2	1200	Amperes
Maximum Collector Dissipation (T <sub>C</sub> = 25°C)*1*4	P <sub>C</sub>	1580	Watts

 $<sup>^{\</sup>star}1$  Case temperature (T<sub>C</sub>) and heatsink temperature (T<sub>f</sub>) are defined on the surface of the baseplate and heatsink at just under the chip.

#### BASEPLATE FLATNESS MEASUREMENT POINT



#### CHIP LOCATION (TOP VIEW)



Dimensions in mm (Tolerance:  $\pm 1\,\text{mm}$ )

<sup>\*2</sup> I<sub>E</sub>, I<sub>EM</sub>, V<sub>EC</sub>, t<sub>rr</sub> and Q<sub>rr</sub> represent ratings and characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

<sup>\*3</sup> Pulse width and repetition rate should be such that device junction temperature  $(T_j)$  does not exceed  $T_{j(max)}$  rating.

<sup>\*4</sup> Junction temperature (T<sub>i</sub>) should not increase beyond T<sub>i(max)</sub> rating.

<sup>\*9</sup> Use both of each main terminal (collector and emitter) to connect external wiring.

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QIS0660004 Single IGBT NX-Series Module 600 Amperes/600 Volts

### Electrical and Mechanical Characteristics, T<sub>i</sub> = 25°C unless otherwise specified

#### **Inverter Sector**

Characteristics		Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector Cutoff	Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0V$	_	_	1.0	mA
Gate-Emitter Th	reshold Voltage	V <sub>GE(th)</sub>	I <sub>C</sub> = 60mA, V <sub>CE</sub> = 10V	5	6	7	Volts
Gate Leakage C	Current	I <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0V$	_	_	0.5	μΑ
Collector-Emitte	r Saturation Voltage	V <sub>CE(sat)</sub>	$I_C = 600A$ , $V_{GE} = 15V$ , $T_j = 25^{\circ}C^{*5}$	_	1.7	2.1	Volts
			$I_C = 600A$ , $V_{GE} = 15V$ , $T_j = 125^{\circ}C^{*5}$	_	1.9	_	Volts
			I <sub>C</sub> = 600A, V <sub>GE</sub> = 15V, Chip	_	1.6	_	Volts
Input Capacitan	ce	C <sub>ies</sub>		_	_	69.0	nF
Output Capacita	ance	C <sub>oes</sub>	$V_{CE} = 10V, V_{GE} = 0V$	_	_	8.0	nF
Reverse Transfer Capacitance		C <sub>res</sub>	<del></del>	_	_	2.4	nF
Total Gate Char	ge	$Q_{G}$	V <sub>CC</sub> = 300V, I <sub>C</sub> = 600A, V <sub>GE</sub> = 15V	_	1600	_	nC
Inductive	Turn-on Delay Time	t <sub>d(on)</sub>		_	_	700	ns
Load	Turn-on Rise Time	t <sub>r</sub>	V <sub>CC</sub> = 300V, I <sub>C</sub> = 600A,	_	_	250	ns
Switch	Turn-off Delay Time	t <sub>d(off)</sub>	$V_{GE} = \pm 15V$ ,	_	_	700	ns
Time	Turn-off Fall Time	t <sub>f</sub>	$R_G = 1.0\Omega, I_E = 600A,$	_	_	600	ns
Reverse Recovery Time		t <sub>rr</sub> *2	Inductive Load Switching Operation	_	_	300	ns
Reverse Recove	ery Charge	Qrr*2	<del></del>	_	11	_	μC
Emitter-Collector Voltage		V <sub>EC</sub> *2	$I_E = 600A$ , $V_{GE} = 0V$ , $T_j = 25^{\circ}C^{*5}$	_	2.0	2.8	Volts
			$I_E = 600A$ , $V_{GE} = 0V$ , $T_i = 125^{\circ}C^{*5}$	_	1.95	_	Volts
			I <sub>E</sub> = 600A, V <sub>GE</sub> = 0V, Chip	_	1.9	_	Volts

## Thermal and Mechanical Characteristics, $T_i = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Module Lead Resistance	R <sub>lead</sub>	Main Termnals-Chip (Per Switch)	_	0.6	_	mΩ
Thermal Resistance, Junction to Case**	R <sub>th(j-c)</sub> Q	Per IGBT*1	_	_	0.079	°C/W
Thermal Resistance, Junction to Case**	R <sub>th(j-c)</sub> D	Per FWDi*1	_	_	0.132	°C/W
Contact Thermal Resistance**	R <sub>th(c-f)</sub>	Case to Heatsink (Per 1 Module)	_	0.015	_	°C/W
		Thermal Grease Applied*1*7				
Internal Gate Resistance	R <sub>Gint</sub>	T <sub>C</sub> = 25°C	2.1	3.0	3.9	Ω
		T <sub>C</sub> = 125°C	4.2	6.0	7.8	Ω
External Gate Resistance	R <sub>G</sub>		1.0	_	10	Ω

### NTC Thermistor Sector, $T_j = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Zero Power Resistance	R	$T_{C} = 25^{\circ}C^{*1}$	4.85	5.00	5.15	kΩ
Deviation of Resistance	ΔR/R	$T_C = 100^{\circ}C, R_{100} = 493\Omega^{*1}$	-7.3	_	+7.8	%
B Constant	B <sub>(25/50)</sub>	$B = (InR_1 - InR_2) / (1/T_1 - 1/T_2)^{*6}$	_	3375	_	K
Power Dissipation	P <sub>25</sub>	$T_{C} = 25^{\circ}C^{*1}$	_	_	10	mW

 $<sup>^{\</sup>star 1} \text{ Case temperature } (T_C) \text{ and heatsink temperature } (T_f) \text{ are defined on the surface of the baseplate and heatsink at just under the chip.} \\$ 

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 $<sup>^{\</sup>star}$ 2 I<sub>E</sub>, I<sub>EM</sub>, V<sub>EC</sub>, t<sub>rr</sub> and Q<sub>rr</sub> represent ratings and characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

<sup>\*5</sup> Pulse width and repetition rate should be such as to cause negligible temperature rise.

<sup>\*6</sup> R<sub>1</sub>: Resistance at Absolute Temperature  $T_1(K)$ , R<sub>2</sub>: Resistance at Absolute Temperature  $T_2(K)$ ,  $T(K) = T(^{\circ}C) + 273.15$ 

<sup>\*7</sup> Typical value is measured by using thermally conductive grease of  $\lambda = 0.9$  [W/(m • K)].

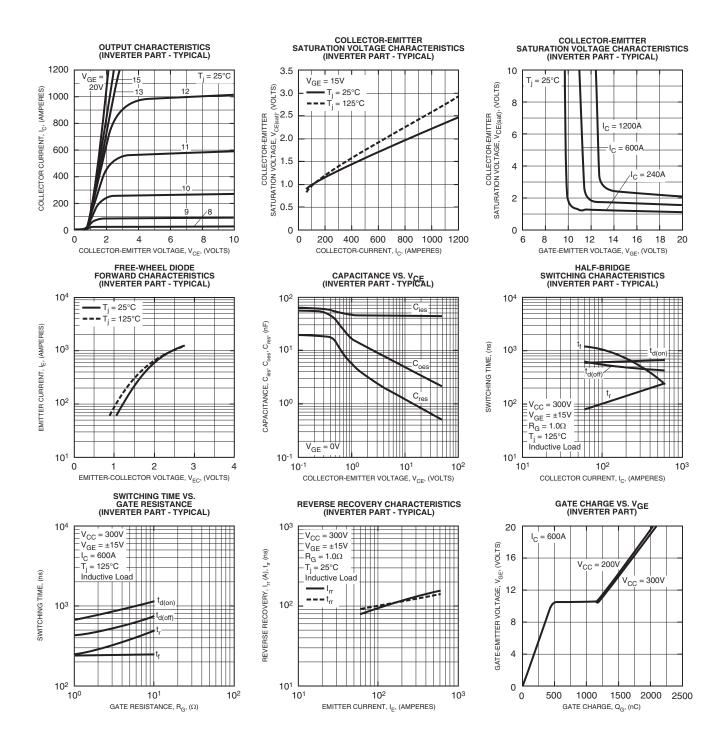
Information presented is based upon manufacturers testing and projected capabilities. This information is subject to change without notice.

The manufacturer makes no claim as to the suitability of use, reliability, capability, or future availability of this product.



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REVERSE RECOVERY SWITCHING LOSS VS.
EMITTER CURRENT
(INVERTER PART - TYPICAL)

10<sup>2</sup>

EMITTER CURRENT,  $I_F$ , (AMPERES)

10<sup>3</sup>

V<sub>CC</sub> = 300V

 $V_{GE} = \pm 15V -$ 

Inductive Load

 $R_G = 1.0\Omega$ 

T<sub>i</sub> = 125°C

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